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U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

PETITION FOR EXTENSION OF TIME UNDER 37 CFR 1.136(a) FY 2005 (Fees pursuant to the Consolidated Appropriations Act, 2005 (H.R. 4818).)		Docket Number (Optional) 51380	
oplication Number 10/078,766		Filed February 19, 2002	
For PROCESS FOR ELECTROPLATING SILICON WAFERS			
Art Unit 1742		Examiner	W. Leader
This is a request under the provisions of 37 CFR 1.136(a) to extend the period for filing a reply in the above identified application. The requested extension and fee are as follows (check time period desired and enter the appropriate fee below):			
One month (37 CFR 1.17(a)(1))	<u>Fee</u> \$120	Small Entity Fee \$60	\$
Two months (37 CFR 1.17(a)(2))	\$450	\$225	\$
X Three months (37 CFR 1.17(a)(3))	\$1020	\$510	\$ 1,020.00
Four months (37 CFR 1.17(a)(4))	\$1590	\$795	\$
Five months (37 CFR 1.17(a)(5))	\$2160	\$1080	\$
Applicant claims small entity status. See 37 CFR 1.27. A check in the amount of the fee is enclosed. Payment by credit card. Form PTO-2038 is attached. X The Director has already been authorized to charge fees in this application to a Deposit Account. X The Director is hereby authorized to charge any fees which may be required, or credit any overpayment, to Deposit Account Number			
Signature			3, 2006 Date
Peter F. Corless		(617) 4 <u>39-4444</u>	
Typed or printed name			ne Number
NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.			
Total of 1 forms are submitte	×d.		
I hereby certify that this paper (along with any paper referred to as being sitiached or enclosed) is being transmitted by facsimile to the Patent and Trademark Office, facsimile no. (571) 273-8300, on the date shown below.			
Dated: June 28, 2008 Signature:			

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